

- **CDMA 450 F-Band RF SAW Filter**
- **3.8 x 3.8 x 1.4 mm Surface-mount Package**
- **Complies with Directive 2002/95/EC (RoHS)**

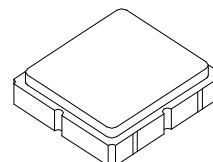


Absolute Maximum Ratings

| Rating | Value | Units |
|--|----------------|-------|
| Maximum Incident Power in Passband | +28 | dBm |
| Maximum DC Voltage Between any Two Terminals | 30 | VDC |
| Storage Temperature Range in Tape and Reel | -40 to +85 | °C |
| Suitable for Lead-free Soldering - Maximum Soldering Profile | 260°C for 30 s | |

SF1201D

**455.0 MHz
SAW Filter**



SM3838-6

Electrical Characteristics

| Characteristic | Sym | Notes | Min | Typ | Max | Units |
|---|-------|---------|--------|-------|-------|-------|
| Nominal 1 dB Center Frequency | f_c | 1 | | 455.0 | | MHz |
| Passband Insertion Loss, 452.5 to 457.5 MHz | IL | | | 1.8 | 2.8 | dB |
| Passband VSWR, 452.5 to 457.5 MHz | | | | 1.2:1 | 2.0:1 | |
| Rejection Referenced to 0 dB: | | 1, 2, 3 | | | | dB |
| 0.3 to 350.0 MHz | | | 30 | 33 | | |
| 350.0 to 445.0 MHz | | | 25 | 30 | | |
| 445.0 to 463.1 MHz | | | 40 | 45 | | |
| 463.1 to 467.5 MHz | | | 30 | 45 | | |
| 467.5 to 2000 MHz | | | 25 | 30 | | |
| Operating Temperature Range | T_A | 1 | -30 | | +85 | °C |
| Single-ended Source Impedance | | | 50 ohm | | | |
| Single-ended Load Impedance | | | 50 ohm | | | |

| | | | | | | |
|--|---|------------------|--|--|--|--|
| Case Style | SM3838-6 3.8 x 3.8 mm Nominal Footprint | | | | | |
| Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator | 601, YWWS | | | | | |
| Standard Reel Quantity | Reel Size 7 Inch | 1000 Pieces/Reel | | | | |
| | Reel Size 13 Inch | 3000 Pieces/Reel | | | | |

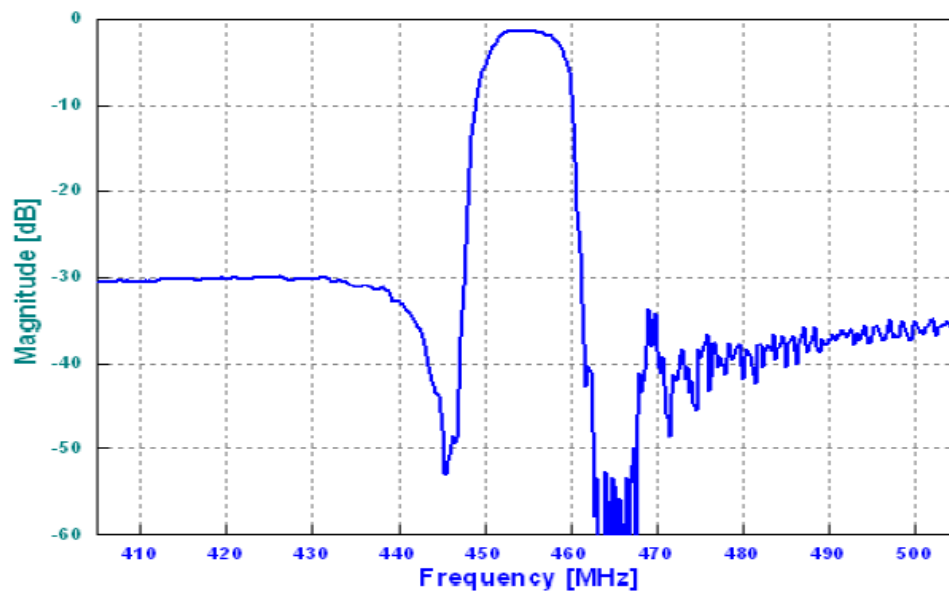
Electrical Connections

| Connection | Terminals |
|-------------|------------|
| Port 1 | 2 |
| Port 2 | 5 |
| Case Ground | All others |

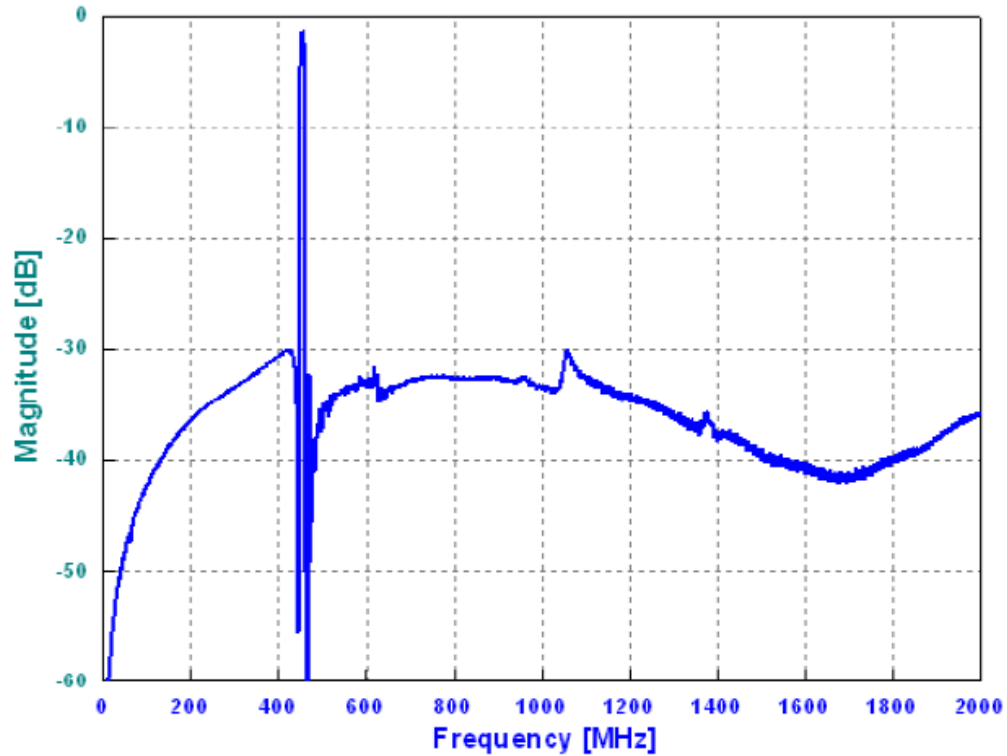
CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

NOTES:

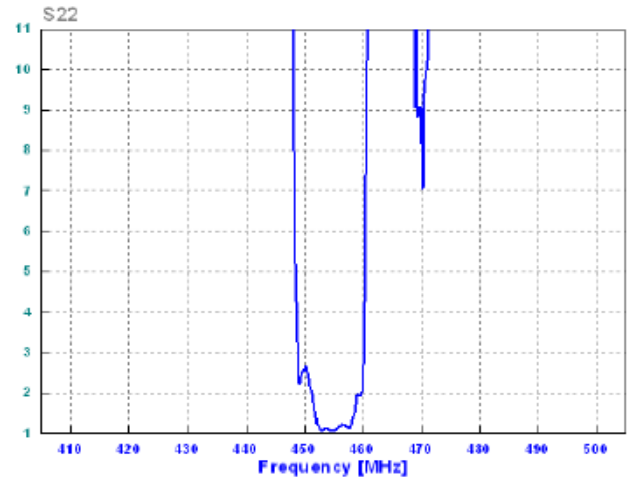
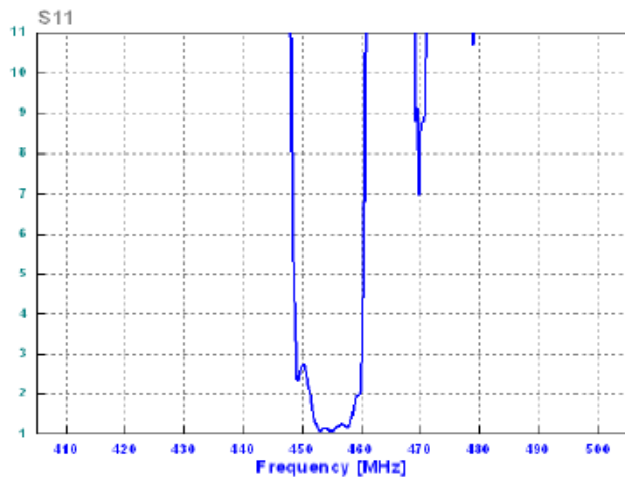
1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, f_c .
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production"
5. and "ENG" or "E" indicates "engineering prototypes."
6. The design, manufacturing process, and specifications of this filter are subject to change.
7. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
8. US and international patents may apply.
9. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.



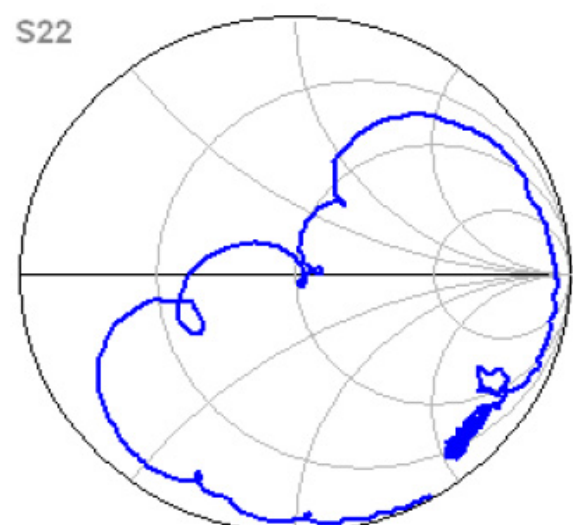
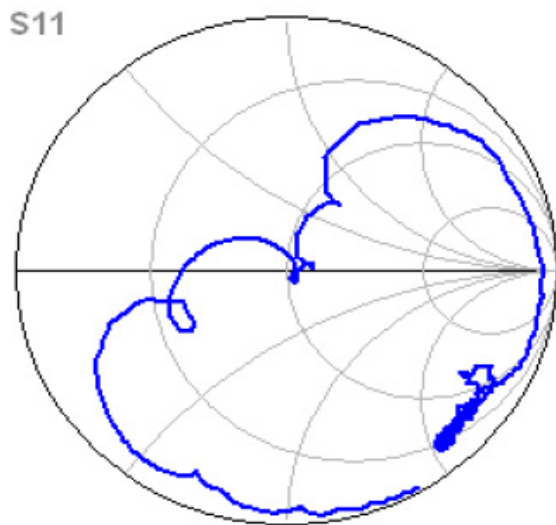
Passband Plot



Wideband Plot



VSWR

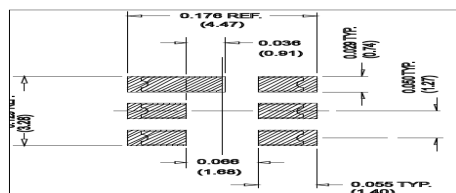
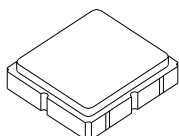


S11 and S22 Plots

SM3838-6 Case

6-Terminal Ceramic Surface-Mount Case

3.8 X 3.8 mm Nominal Footprint



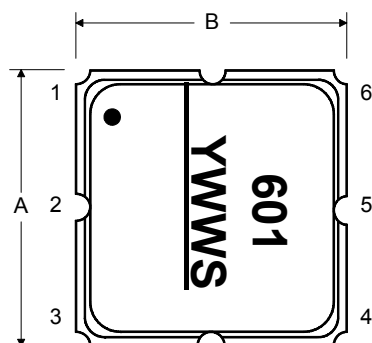
PCB Footprint

| Case Dimensions | | | | | | |
|-----------------|------|------|------|--------|-------|-------|
| Dimension | mm | | | Inches | | |
| | Min | Nom | Max | Min | Nom | Max |
| A | 3.60 | 3.80 | 4.0 | 0.14 | 0.15 | 0.16 |
| B | 3.60 | 3.80 | 4.0 | 0.14 | 0.15 | 0.16 |
| C | 1.30 | 1.50 | 1.70 | 0.05 | 0.06 | 0.067 |
| D | 0.95 | 1.10 | 1.25 | 0.037 | 0.043 | 0.05 |
| E | 2.39 | 2.54 | 2.69 | 0.090 | 0.10 | 0.110 |
| G | 0.90 | 1.0 | 1.10 | 0.035 | 0.04 | 0.043 |
| H | 1.90 | 2.0 | 2.10 | 0.75 | 0.08 | 0.83 |
| I | 0.50 | 0.6 | 0.70 | 0.020 | 0.024 | 0.028 |
| J | 1.70 | 1.8 | 1.90 | 0.067 | 0.07 | 0.075 |

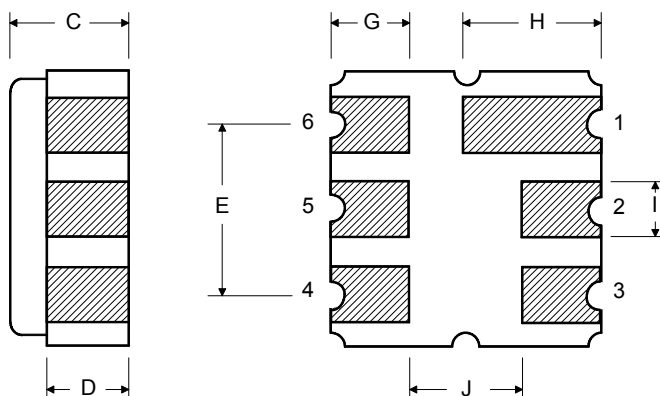
| Electrical Connections | | |
|-----------------------------|---------------------|------------|
| Connection | | Terminals |
| Port 1 | Single-ended Input | 2 |
| Port 2 | Single-ended Output | 5 |
| | Ground | All others |
| Single-ended Operation Only | | |
| Dot indicates Pin 1 | | |

| Materials | |
|--------------------|--|
| Solder Pad Plating | 0.3 to 1.0 μ m Gold over 1.27 to 8.89 μ m Nickel |
| Lid Plating | 2.0 to 3.0 μ m Nickel |
| Body | Al ₂ O ₃ Ceramic |
| Pb Free | |

TOP VIEW



BOTTOM VIEW



Technical drawing of a circular component, likely a flange or end plate, showing three views: a top view, a side view, and a detail view.

Top View: A large circle with a smaller concentric circle in the center. A crosshair indicates the center. A leader line points from the text "See Detail 'A'" to the central hole.

Side View: A vertical cross-section showing the thickness of the component. The total thickness is dimensioned as 12.0. The central hole has a diameter of 100 REF. The outer diameter is dimensioned as "B" REF.

Detail View (Detail A): A cross-section of the central hole. It shows a circular hole with a diameter of 20.2. The hole is surrounded by a flange with a thickness of 2.0. The outer diameter of the flange is dimensioned as 13.0.

| “B” Nominal Size | | Quantity Per Reel |
|---------------------|-------------|-------------------|
| Inches | millimeters | |
| 7 | 178 | 1000 |
| 13 | 330 | 3000 |

| Carrier Tape Dimensions | |
|-------------------------|---------|
| Ao | 4.25 mm |
| Bo | 4.25 mm |
| Ko | 1.30 mm |
| Pitch | 8.0 mm |
| W | 12.0 mm |

